

## 1 Mbit/s High Speed Transistor Coupler

#### **Features**

- High speed 1Mbit/s
- High isolation voltage between input and output (Viso=3750 Vrms)
- Guaranteed CTR performance from 0 °C to 70 °C
- Wide operating temperature range of -40 °C to 100 °C
- Green Package
- Regulatory Approvals
  - UL UL1577 (E364000)
  - VDE EN60747-5-5(VDE0884-5)
  - CQC GB4943.1, GB8898
  - IEC60065, IEC60950

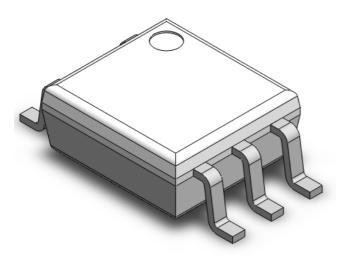
#### **Description**

The CTM452 and CTM453 devices each consist of an infrared emitting diode, optically coupled to a high speed photo detector transistor. A separate connection the bias for photodiode output-transistor collector increase the speed by several orders of magnitude over conventional phototransistor couplers reducing by the base-collector capacitance of the input transistor. The devices are packaged in a Mini-Flat package.

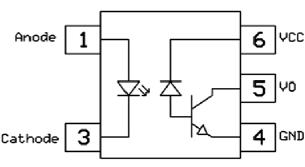
#### **Applications**

- Line receivers
- Telecommunication equipment
- Feedback loop in switch-mode power supplies
- Home appliances
- High speed logic ground isolation

## **Package Outline**



### **Schematic**





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## Absolute Maximum Rating at 25°C

Symbol	Parameters	Ratings	Units	Notes
Viso	Isolation voltage *1	3750	V <sub>RMS</sub>	
Topr	Operating temperature	-55 ~ +100	°C	
Тѕтс	Storage temperature	-55 ~ +125	°C	
Tsol	Soldering temperature *2	260	°C	
Emitter				
lF	Forward current	25	mA	
I <sub>FP</sub>	Peak forward current (50% duty, 1ms P.W)	50	mA	
I <sub>F(TRANS)</sub>	Peak transient current (≤1µs P.W,300pps)	1	А	
V <sub>R</sub>	Reverse voltage	5	V	
PD	Power dissipation	45	mW	
Detector				
PD	Power dissipation	100	mW	
I <sub>O(AVG)</sub>	Average Output current	8	mA	
I <sub>O (Peak)</sub>	Peak Output current	16	mA	
Vo	Output voltage	-0.5 to 20	V	
Vcc	Supply voltage	-0.5 to 30	V	



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#### **Electrical Characteristics**

 $T_A$  = 0 - 70 °C (unless otherwise specified). Typical values are measured at  $T_A$  = 25°C and  $V_{CC}$ =5V

#### **Emitter Characteristics**

Symbol	Parameters	Test Conditions	Min	Тур	Max	Units	Notes
VF	Forward voltage	IF = 16mA	-	1.45	1.6	V	
VR	Reverse Voltage	IR = 10μA	5.0	-	-	V	
$\Delta V_F/\Delta T_A$	Temperature coefficient of forward voltage	IF =16mA	-	-1.6	-	mV/℃	

#### **Detector Characteristics**

Symbol	Parameters	Test Conditions	Min	Тур	Max	Units	Notes
	Logic High Output Current	I <sub>F</sub> =0mA, V <sub>O</sub> =V <sub>CC</sub> =5.5V,	-	0.001	0.5		
		T <sub>A</sub> =25℃					
Іон		I <sub>F</sub> =0mA, V <sub>O</sub> =V <sub>CC</sub> =15V,		0.01	1 50	μΑ	
		T <sub>A</sub> =25℃	-				
		I <sub>F</sub> =0mA, V <sub>O</sub> =V <sub>CC</sub> =15V	1	-			
ICCL	Lacia Law Cumhy Cumont	I <sub>F</sub> =16mA, V <sub>O</sub> =Open,	-	120	200	μА	
ICCL	Logic Low Supply Current	Vcc=15V					
	Icch Logic High Supply Current  IF=0mA, Vo=Open, Vcc=15V, T <sub>A</sub> =25 ℃  IF=0mA, VO=Open, VCC=15V		- 0.01	1			
loou		T <sub>A</sub> =25 ℃	,	0.01	'	μΑ	
ICCH		IF=0mA, VO=Open,			2	μΑ	
		-	_	2			



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#### **Transfer Characteristics**

Symbol	Parameters	Test Conditions	Min	Тур	Max	Units	Notes
OTD	Current Transfer Ratio	I <sub>F</sub> =16mA, V <sub>O</sub> =0.4V,	20	-	50		
		V <sub>CC</sub> =4.5V, T <sub>A</sub> =25 °C	20			%	
CTR		I <sub>F</sub> =16mA, V <sub>O</sub> =0.5V,	4.5	-	-	70	
		V <sub>CC</sub> =4.5V	15				
	Logic Low Output Voltage	I <sub>F</sub> =16mA, I <sub>O</sub> =3mA, V <sub>CC</sub> =4.5V,	-	-	0.4		
.,,		T <sub>A</sub> =25℃				V	
V <sub>OL</sub>		I <sub>F</sub> =16mA, I <sub>O</sub> =2.4mA,	-		0.5	V	
		V <sub>CC</sub> =4.5V		-			

#### **Electrical Characteristics**

 $T_A$  = 0 - 70 °C (unless otherwise specified). Typical values are measured at  $T_A$  = 25°C and  $V_{CC}$ =5V

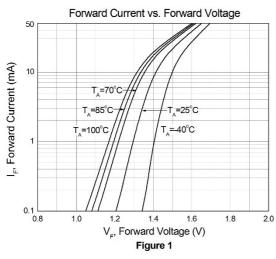
#### **Switching Characteristics**

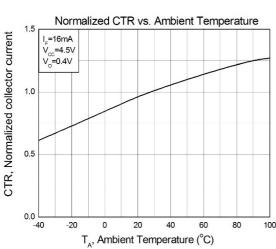
Symbol	Parameters		Test Conditions	Min	Тур	Max	Units	Notes
	Propagation Delay Time Logic High to Logic Low		$I_F=16mA, R_L=1.9K\Omega,$	-	0.35	0.8		
T <sub>PHL</sub>			T <sub>A</sub> =25℃				μs	
	to Logic Low		$I_F=16mA, R_L=1.9K\Omega$	-	-	1.0		
	December Delega Time I a in I		$I_F=16mA, R_L=1.9K\Omega,$		0.3	0.0		
T <sub>PLH</sub>	Propagation Delay Time L	Logic Low	T <sub>A</sub> =25℃	-	0.5	0.8	μs	
	to Logic High		$I_F=16mA, R_L=1.9K\Omega$	-	ı	1.0		
	Common Mode	Common Mode CTM452	$I_F = 0mA$ , $V_{CM}=10Vp-p$ ,	5,000	-			
СМн	Transient Immunity at	G1101432	R <sub>L</sub> =1.9KΩ, T <sub>A</sub> =25 ℃				V/µs	
CIVIH	Logic High	CTM453	I <sub>F</sub> = 0mA , V <sub>CM</sub> =1500Vp-p,	15,000	_		ν/μδ	
	Logic Flight	01101433	R <sub>L</sub> =1.9KΩ, T <sub>A</sub> =25℃	13,000	-			
	Common Mode	CTM452	I <sub>F</sub> = 16mA , V <sub>CM</sub> =10Vp-p,	5,000	_	_		
CML	Transient Immunity at Logic Low	01101432	R <sub>L</sub> =1.9KΩ, T <sub>A</sub> =25°C	3,000			V/uo	
CIVIL		CTMAES	$I_F = 16mA$ , $V_{CM}=1500Vp-p$ ,	15.000			V/µs	
		15,000	-					

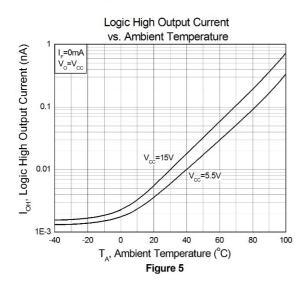


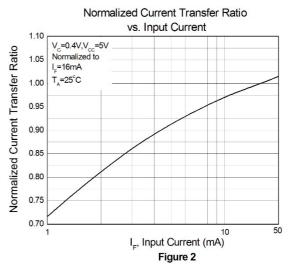
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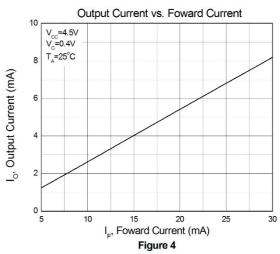
#### **Typical Characteristic Curves**

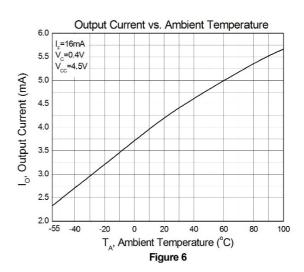








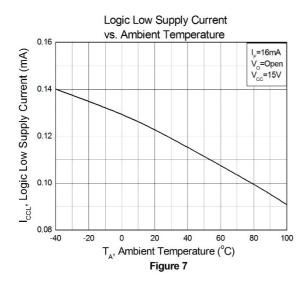


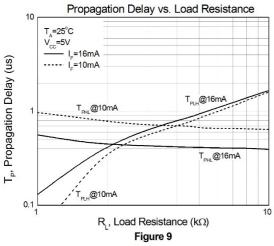


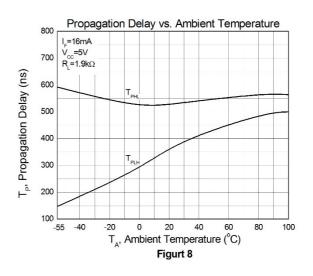


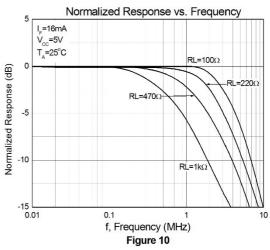
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## **Typical Characteristic Curves**





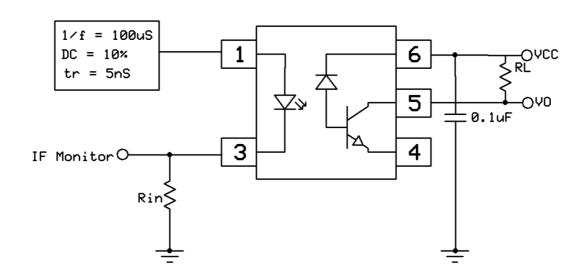


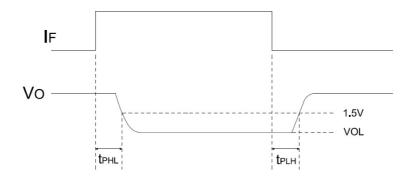




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#### **Test Circuits**



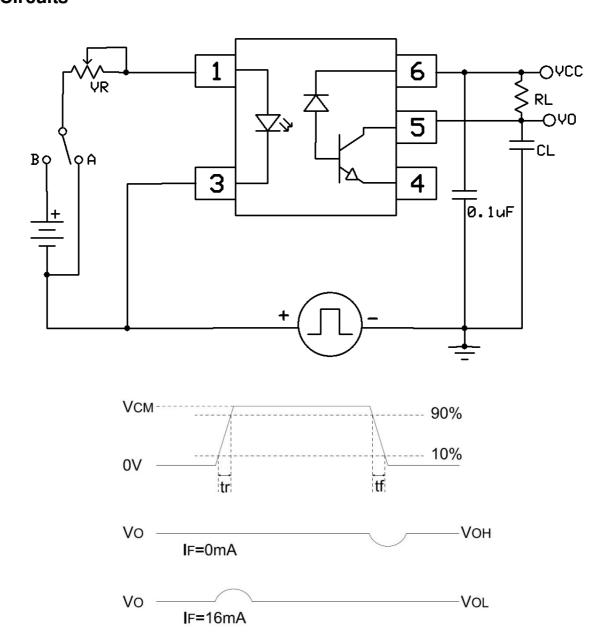


Switching Time Test Circuit



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#### **Test Circuits**

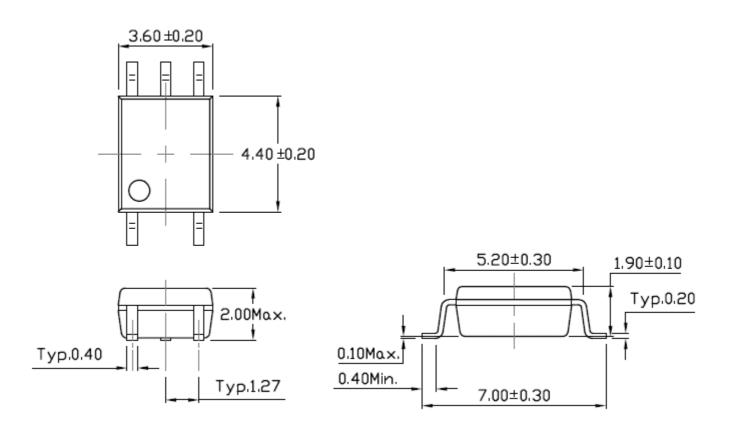


CMR Test Circuit

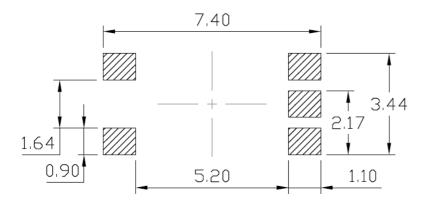


## 1 Mbit/s High Speed Transistor Coupler

#### Package Dimension Dimensions in mm unless otherwise stated



## Recommended Solder Mask Dimensions in mm unless otherwise stated





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#### **Marking Information**



#### Note:

CT : Denotes "CT Micro" M453 : Product Number

V : VDE Option Y : Fiscal Year WW : Work Week

K : Production Code

## **Ordering Information**

## CTM45X(V)(Z)

X = Part No. (X=2 or 3)

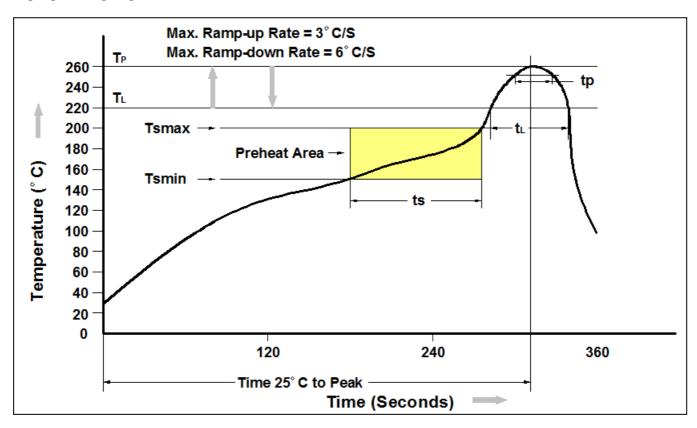
V = VDE Option (V or none)

Z = Tape and reel option (T1 or T2)

Option	Description	Quantity
T1	Surface Mount Lead Forming – With Option 1 Taping	3000 Units/Reel
T2	Surface Mount Lead Forming – With Option 2 Taping	3000 Units/Reel

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#### **Reflow Profile**



Profile Feature	Pb-Free Assembly Profile
Temperature Min. (Tsmin)	150℃
Temperature Max. (Tsmax)	200℃
Time (ts) from (Tsmin to Tsmax)	60-120 seconds
Ramp-up Rate (t <sub>L</sub> to t <sub>P</sub> )	3 ℃/second max.
Liquidous Temperature (T <sub>L</sub> )	217℃
Time (t <sub>L</sub> ) Maintained Above (T <sub>L</sub> )	60 – 150 seconds
Peak Body Package Temperature	260℃ +0℃ / -5℃
Time (t <sub>P</sub> ) within 5 °C of 260 °C	30 seconds
Ramp-down Rate (T <sub>P</sub> to T <sub>L</sub> )	6°C/second max
Time 25 °C to Peak Temperature	8 minutes max.



# 5 Pin Mini-Flat

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